Pb Free Product



NCE P-Channel Enhancement Mode Power MOSFET

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Description

The NCE01P18L uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

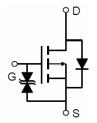
- V_{DS} =-100V, I_{D} =-18A $R_{DS(ON)}$ <100mΩ @ V_{GS} =-10V (Typ:85mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

Application

- Power management in notebook computer
- Portable equipment and battery powered systems

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-251S top view

Package Marking and Ordering Information

	<u> </u>				
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P18L	NCE01P18L	TO-251S	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-100	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	-18	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	-12	Α
Pulsed Drain Current	I _{DM}	-72	А
Maximum Power Dissipation	P _D	70	W
Derating factor		0.56	W /℃
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}\mathbb{C}$



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NCE01P18L

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{eJc}	1.79	°C/W	Ì
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Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u> </u>		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-100	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±20	μA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1	-1.9	-3	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-16A	-	85	100	mΩ
Forward Transconductance	g FS	V _{DS} =-50V,I _D =-10A	5	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	1300	-	PF
Output Capacitance	C _{oss}	V_{DS} =-25V, V_{GS} =0V, F=1.0MHz	-	400	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVID2	-	240	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	16	-	nS
Turn-on Rise Time	t _r	V _{DD} =-50V,I _D =-16A	-	73	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =9.1 Ω	-	34	-	nS
Turn-Off Fall Time	t _f		-	57	-	nS
Total Gate Charge	Qg	\/ - 90\/ - 164	-	61	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-80V, I_{D} =-16A, V_{GS} =-10V	-	14	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =-10V	-	29	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-18A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	-18	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-18A	-	88.3	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	65.9	-	nC
	- 1	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

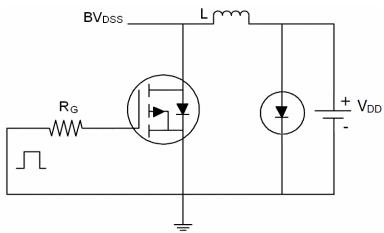
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=-50V,V_G=-10V,L=0.5mH,Rg=25 Ω

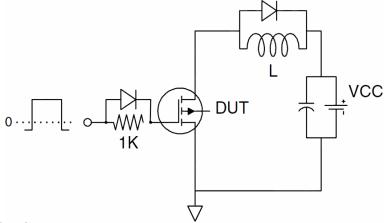


Test Circuit

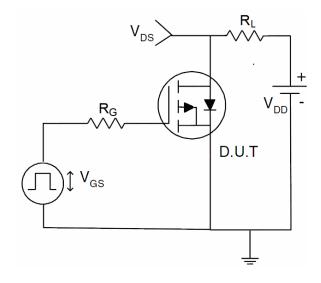
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

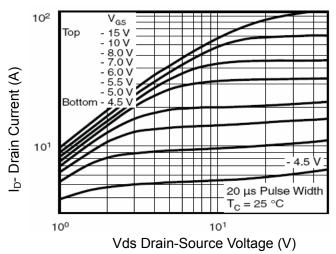


Figure 1 Output Characteristics

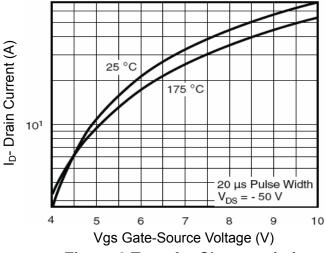


Figure 2 Transfer Characteristics

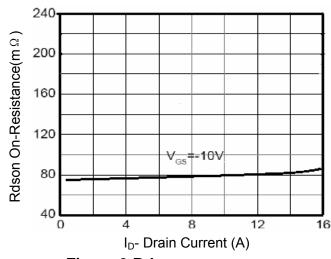


Figure 3 Rdson- Drain Current

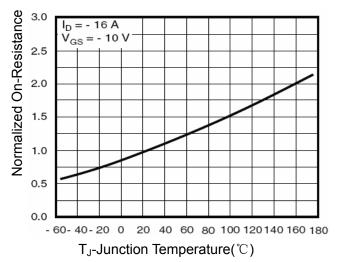


Figure 4 Rdson-JunctionTemperature

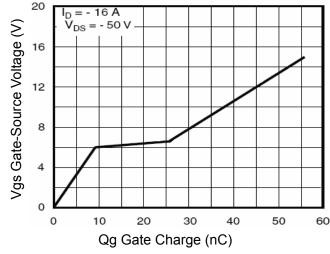


Figure 5 Gate Charge

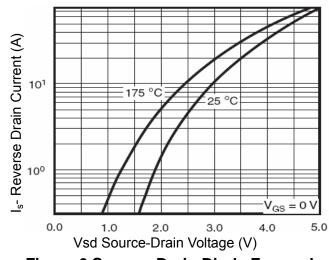
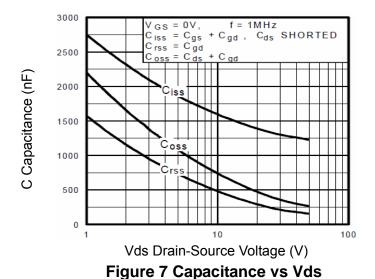


Figure 6 Source- Drain Diode Forward





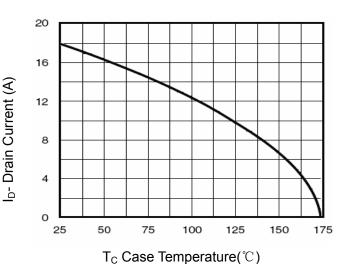


Figure 9 Drain Current vs Case Temperature

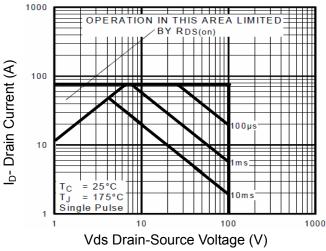


Figure 8 Safe Operation Area

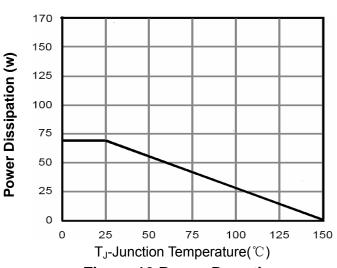


Figure 10 Power De-rating

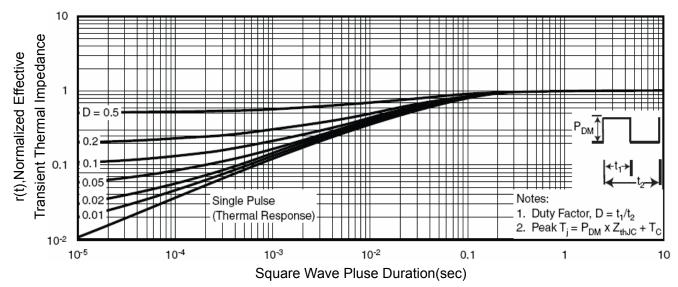
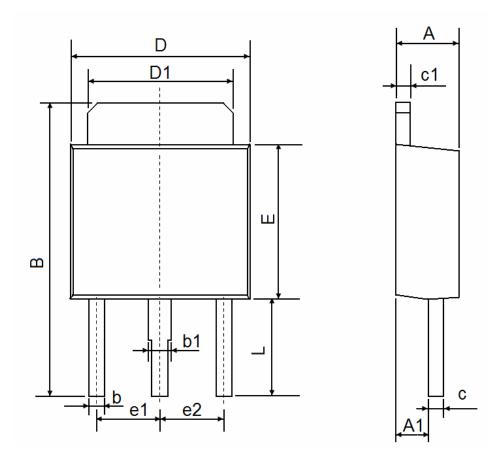


Figure 11 Normalized Maximum Transient Thermal Impedance

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TO-251S Package Information



Comple ed	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.250	2.350	0.089	0.093	
A1	1.150	1.250	0.045	0.049	
В	10.200	10.800	0.402	0.425	
b	0.550	0.650	0.022	0.026	
b1	0.750	0.850	0.030	0.033	
С	0.480	0.540	0.019	0.021	
c1	0.480	0.540	0.019	0.021	
D	6.400	6.600	0.252	0.260	
D1	5.250	5.350	0.207	0.211	
E	5.400	5.600	0.213	0.220	
e1	2.300 TYP		0.091 TYP		
e2	2.300 TYP		0.091 TYP		
L	3.300	3.700	0.130	0.146	



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